

MM74HC08 Quad 2-Input AND Gate

Features

- Typical propagation delay: 7ns (t_{PHL}), 12ns (t_{PLH})
- Fanout of 10 LS-TTL loads
- Quiescent power consumption: 2µA maximum at room temperature
- Low input current: 1µA maximum

General Description

The MM74HC08 AND gates utilize advanced silicongate CMOS technology to achieve operating speeds similar to LS-TTL gates with the low power consumption of standard CMOS integrated circuits. The HC08 has buffered outputs, providing high noise immunity and the ability to drive 10 LS-TTL loads. The 74HC logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

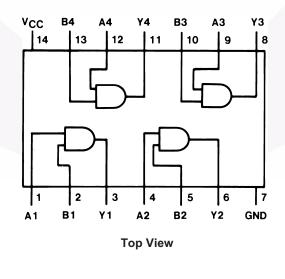
Ordering Information

Order Number	Package Number	Package Description
MM74HC08M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HC08SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC08MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC08N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel except for N14A. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagram



©1983 Fairchild Semiconductor Corporation MM74HC08 Rev. 1.4.0

www.fairchildsemi.com

Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5 to +7.0V
V _{IN}	DC Input Voltage	–1.5 to V _{CC} +1.5V
V _{OUT}	DC Output Voltage	–0.5 to V _{CC} +0.5V
I _{IK} , I _{OK}	Clamp Diode Current	±20mA
I _{OUT}	DC Output Current, per pin	±25mA
I _{CC}	DC V _{CC} or GND Current, per pin	±50mA
T _{STG}	Storage Temperature Range	–65°C to +150°C
PD	Power Dissipation	
	Note 2	600mW
	S.O. Package only	500mW
ΤL	Lead Temperature (Soldering 10 seconds)	260°C

Notes:

1. Unless otherwise specified all voltages are referenced to ground.

2. Power Dissipation temperature derating — plastic "N" package: -12mW/°C from 65°C to 85°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V _{CC}	Supply Voltage	2	6	V
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V
T _A	Operating Temperature Range	-40	+85	°C
t _r , t _f	Input Rise or Fall Times			
	$V_{CC} = 2.0V$		1000	ns
	$V_{CC} = 4.5V$		500	ns
	$V_{CC} = 6.0 V$		400	ns

MM74HC08 — Quad 2-Input AND Gate

				T _A =	25°C	T _A =-40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур.		Guaranteed	Limits	Unit
V _{IH}	Minimum HIGH Level	2.0			1.5	1.5	1.5	V
	Input Voltage	4.5			3.15	3.15	3.15	1
		6.0			4.2	4.2	4.2	1
V _{IL}	Maximum LOW Level	2.0			0.5	0.5	0.5	V
	Input Voltage	4.5			1.35	1.35	1.35	1
		6.0			1.8	1.8	1.8	1
V _{OH}	Minimum HIGH Level	2.0	$V_{IN} = V_{IH},$	2.0	1.9	1.9	1.9	V
	Output Voltage	4.5	I _{OUT} ≤ 20μΑ	4.5	4.4	4.4	4.4	1
		6.0		6.0	5.9	5.9	5.9	1
		4.5	$V_{IN} = V_{IH},$ $ I_{OUT} \le 4.0 \text{mA}$	4.2	3.98	3.84	3.7	
		6.0	$V_{IN} = V_{IH},$ $ I_{OUT} \le 5.2mA$	5.7	5.48	5.34	5.2	
	Maximum LOW Level Output Voltage	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 20 \mu A$	0	0.1	0.1	0.1	V
		4.5		0	0.1	0.1	0.1	
		6.0		0	0.1	0.1	0.1	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 4.0 \text{mA}$	0.2	0.26	0.33	0.4	
		6.0	$\begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL}, \\ \left I_{OUT} \right \leq 5.2 \text{mA} \end{array}$	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	6.0	$V_{IN} = V_{CC}$ or GND		±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	6.0	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0\mu A$		2.0	20	40	μA

3. For a power supply of 5V ±10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

DC Electrical Characteristics⁽³⁾

AC Electrical Characteristics

 $V_{CC} = 5V, \ T_A = 25^{\circ}C, \ C_L = 15pF, \ t_r = t_f = 6ns$

Symbol	Parameter	Conditions	Тур.	Guaranteed Limit	Units
t _{PHL}	Maximum Propagation Delay, Output HIGH-to-LOW		12	20	ns
t _{PLH}	Maximum Propagation Delay, Output LOW-to-HIGH		7	15	ns

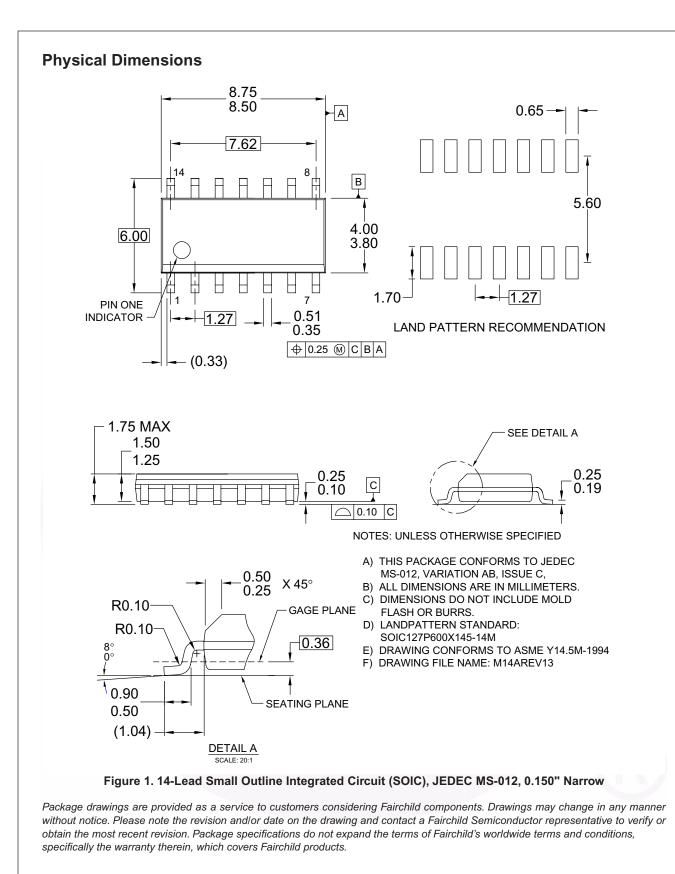
AC Electrical Characteristics

 V_{CC} = 2.0V to 6.0V, C_L = 50pF, t_r = t_f = 6ns (unless otherwise specified)

				T _A =	25°C	T _A = -40°C to 125°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур.	Guara	nteed Limits	Units
t _{PHL}	Maximum Propagation Delay,	2.0		77	121	175	ns
	Output HIGH-to-LOW	4.5		15	24	35	
		6.0		13	20	30	
t _{PLH}	Maximum Propagation Delay,	2.0		30	90	134	ns
	Output LOW-to-HIGH	4.5		10	18	27	
		6.0		8	15	23	
t _{TLH} , t _{THL}	TLH, t _{THL} Maximum Output Rise and Fall			30	75	110	ns
	Time	4.5		8	15	22	
		6.0		7	13	19	
C _{PD}	Power Dissipation Capacitance ⁽⁴⁾		(per gate)	38			pF
C _{IN}	Maximum Input Capacitance			4	10	10	pF

Note:

4. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

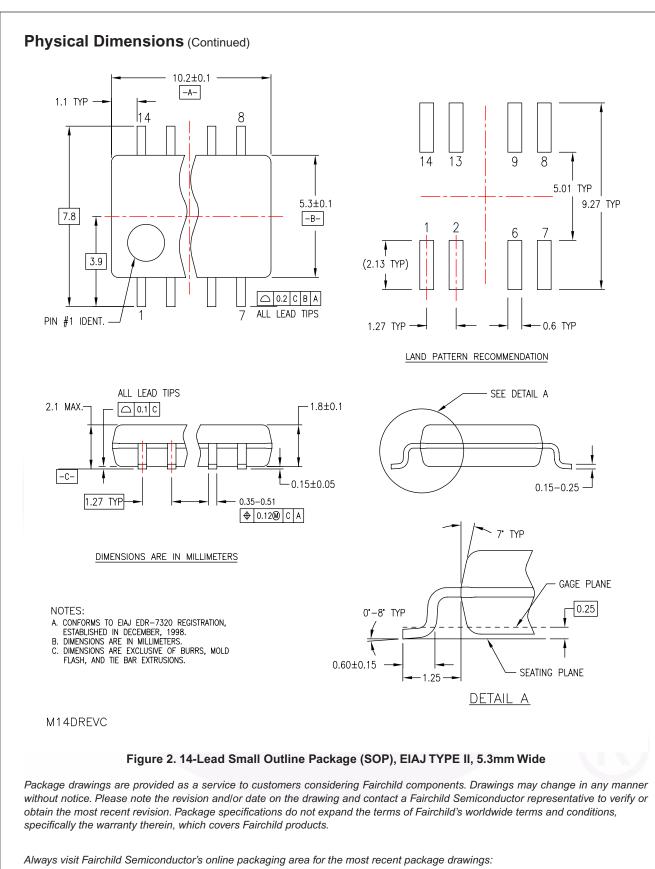


Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/packaging/

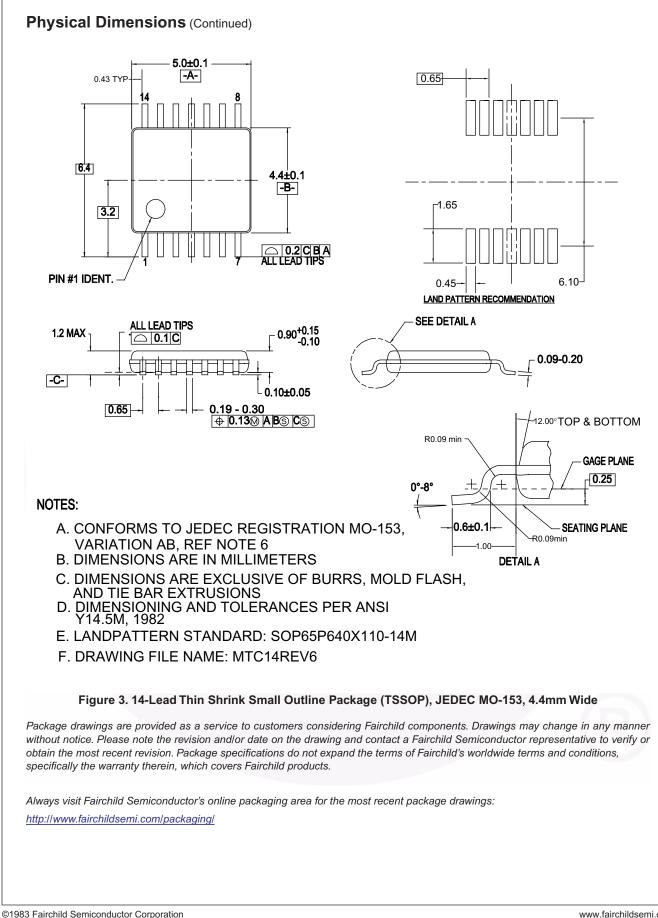
Downloaded from Elcodis.com electronic components distributor

MM74HC08 — Quad 2-Input AND Gate



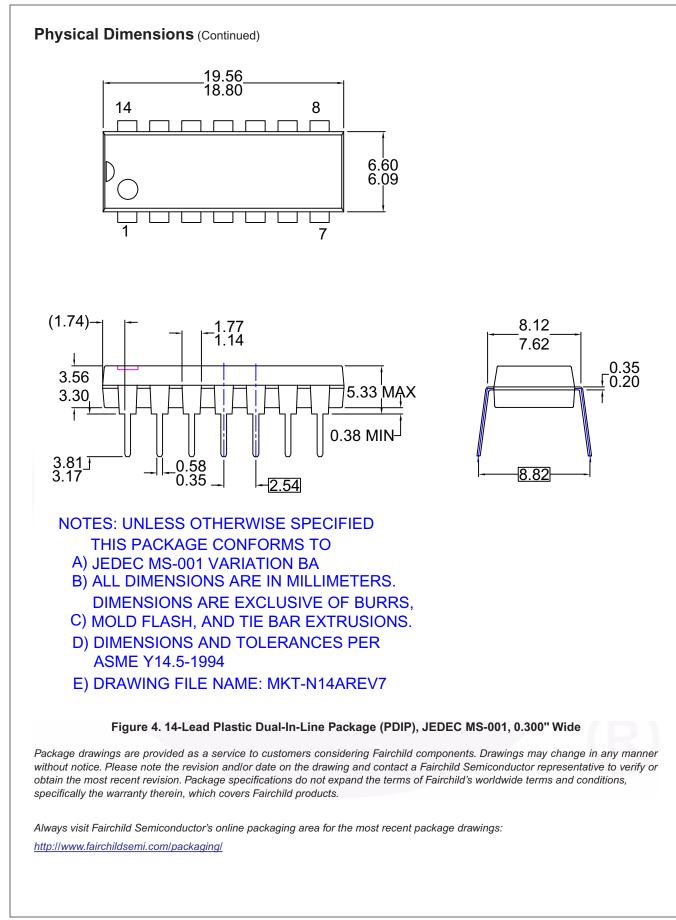
http://www.fairchildsemi.com/packaging/

©1983 Fairchild Semiconductor Corporation MM74HC08 Rev. 1.4.0



MM74HC08 Rev. 1.4.0

MM74HC08 — Quad 2-Input AND Gate



©1983 Fairchild Semiconductor Corporation MM74HC08 Rev. 1.4.0

MM74HC08 — Quad 2-Input AND Gate



SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

ACEx [®] Build it Now [™] CorePLUS [™] CROSSVOLT [™] CTL [™] Current Transfer Logic [™] EcoSPARK [®] EZSWITCH [™] * Fairchild [®] Fairchild [®] Fairchild Semiconductor [®] FACT Quiet Series [™] FACT [®] FastvCore [™] FlashWriter [®]	FPS™ FRFET [®] Global Power Resource SM Green FPS™ Green FPS™ e-Series™ GTO™ <i>i-Lo</i> ™ IntelliMAX™ ISOPLANAR™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroFET™ MicroPak™ MillerDrive™ Motion-SPM™ OPTOLOGIC [®] OPTOPLANAR [®]	PDP-SPM [™] Power220 [®] POWEREDGE [®] Power-SPM [™] PowerTrench [®] Programmable Active Droop [™] QFET [®] QS [™] QT Optoelectronics [™] Quiet Series [™] RapidConfigure [™] SMART START [™] SMART START [™] SPM [®] STEALTH [™] SuperFET [™] SuperFCT [™] 3 SuperSOT [™] 6 SuperSOT [™] 8	SupreMOS [™] SyncFET [™] System Generation The Power Franchise [®] The Power [*] franchise TinyBoost [™] TinyBuck [™] TinyBuck [™] TinyLogic [®] TINYOPTO [™] TinyPOwer [™] TinyPWM [™] TinyWire [™] UserDes [™] UHC [®] Ultra FRFET [™] UniFET [™] VCX [™]
---	--	--	---

* EZSWITCH™ and FlashWriter[®] are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

PRODUCT STATUS DEFINITIONS

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 1. Life support devices or systems are devices or systems 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.

©1983 Fairchild Semiconductor Corporation MM74HC08 Rev. 1.4.0